

## 2.0x1.25mm BI-COLOR SMD CHIP LED LAMP

Part Number: APB2012CGKSEKC

Green

Super Bright Orange

### **Features**

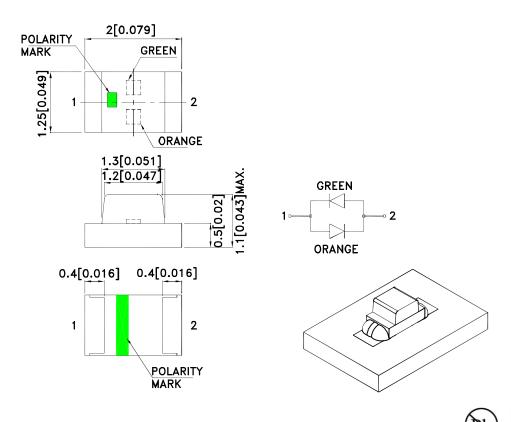
- 2.0mmx1.25mm SMT LED, 1.1mm thickness.
- Bi -color,Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

## Description

The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

The Super Bright Orange device is made with AlGaInP (on GaAs substrate) light emitting diode chip.

## **Package Dimensions**



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.15(0.006") unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.

SPEC NO: DSAM3696 **REV NO: V.2A** DATE: MAR/04/2013 PAGE: 1 OF 6 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Q.M.Chen ERP: 1203013154

## **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APB2012CGKSEKC	Green (AlGaInP)	- Water Clear	20	50	150°
			*20	*50	
	Super Bright Orange (AlGaInP)		120	250	
			*80	*180	

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
  2. Luminous intensity/ luminous Flux: +/-15%.

  \* Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

## Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions	
λpeak	Peak Wavelength	Green Super Bright Orange	574 610		nm	IF=20mA	
λD [1]	Dominant Wavelength	Green Super Bright Orange	570 601		nm	Ir=20mA	
Δλ1/2	Spectral Line Half-width	Green Super Bright Orange	20 29		nm	Ir=20mA	
С	Capacitance	Green Super Bright Orange	15 15		pF	V <sub>F</sub> =0V;f=1MHz	
VF [2]	Forward Voltage	Green Super Bright Orange	2.1 2.1	2.5 2.5	V	/ IF=20mA	

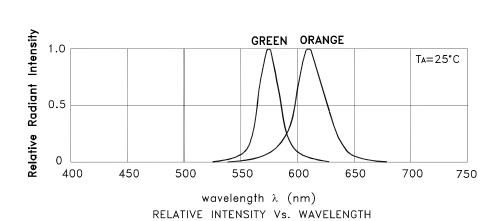
- 1.Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

## Absolute Maximum Ratings at TA=25°C

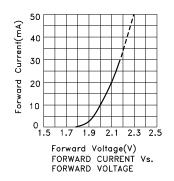
Parameter	Green	Super Bright Orange Uni			
Power dissipation	75	75	mW		
DC Forward Current	30	30	mA		
Peak Forward Current [1]	150	195	mA		
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

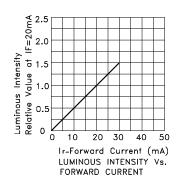
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

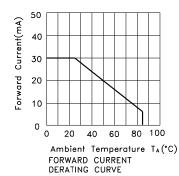
SPEC NO: DSAM3696 **REV NO: V.2A** DATE: MAR/04/2013 PAGE: 2 OF 6 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Q.M.Chen ERP: 1203013154

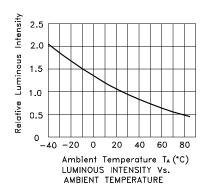


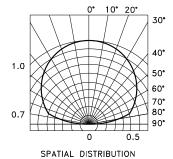
## APB2012CGKSEKC Green





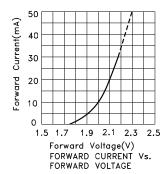


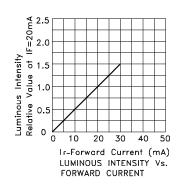


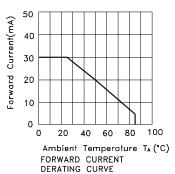


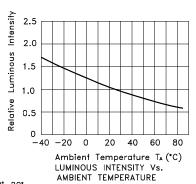
SPEC NO: DSAM3696 REV NO: V.2A DATE: MAR/04/2013 PAGE: 3 OF 6
APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Q.M.Chen ERP: 1203013154

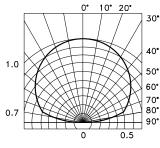
## **Super Bright Orange**











SPATIAL DISTRIBUTION

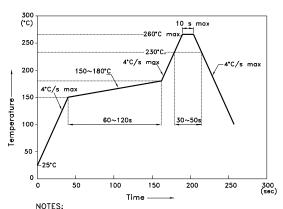
 SPEC NO: DSAM3696
 REV NO: V.2A
 DATE: MAR/04/2013
 PAGE: 4 OF 6

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: Q.M.Chen
 ERP: 1203013154

## APB2012CGKSEKC

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



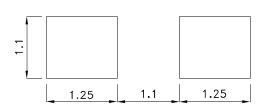
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

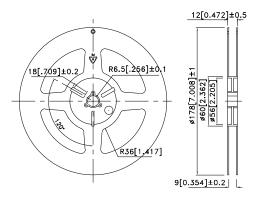
  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
  - to high temperature.

    3.Number of reflow process shall be 2 times or less.

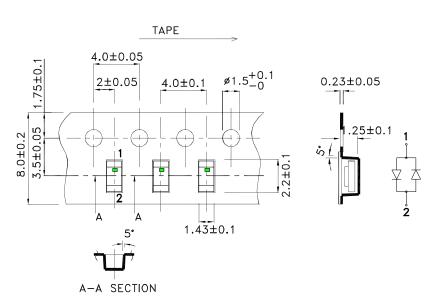
## Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



## **Reel Dimension**



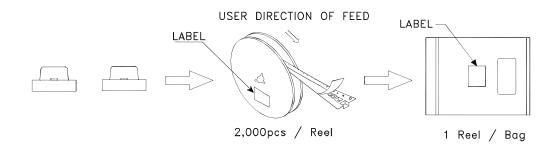
Tape Dimensions (Units : mm)

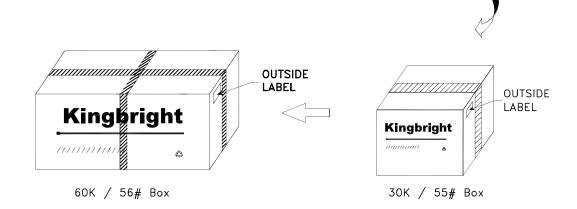


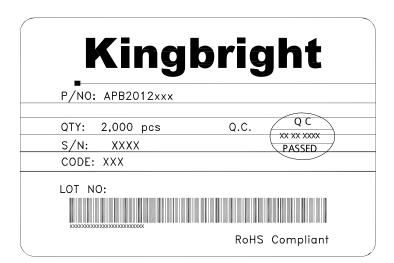
SPEC NO: DSAM3696 APPROVED: WYNEC REV NO: V.2A CHECKED: Allen Liu DATE: MAR/04/2013 DRAWN: Q.M.Chen PAGE: 5 OF 6 ERP: 1203013154

## **PACKING & LABEL SPECIFICATIONS**

## APB2012CGKSEKC







All design applications should refer to Kingbright application notes available at <a href="http://www.KingbrightUSA.com/ApplicationNotes">http://www.KingbrightUSA.com/ApplicationNotes</a>

SPEC NO: DSAM3696 APPROVED: WYNEC REV NO: V.2A CHECKED: Allen Liu DATE: MAR/04/2013 DRAWN: Q.M.Chen PAGE: 6 OF 6 ERP: 1203013154